IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Cheung

Docket No: TI-32390

Serial No:

09/965,143

Examiner:

Shin, Christopher

Filed:

9/27/2001

Art Unit:

2182

For:

METHOD AND DEVICE FOR PROVIDING A LOW POWER EMBEDDED

SYSTEM BUS ARCHITECTURE

AMENDMENT UNDER 37 C.F.R. § 1.116

Assistant Commissioner For Patents Washington, DC 20231

CERTIFICATION OF FACSIMILE TRANSMISSION

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Office at 703-872-9306 on 3-17-0

Tommie Chambers

Dear Sir:

Responsive to the Office Action mailed January 14, 2005 in connection with the above identified application, Applicants respectfully submit the following amendments and remarks.

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Technology Unit: 2182

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From:

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Texas Instruments Incorporated

Facsimile: 972-917-4418 Phone: 972-917-5633

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FACSIMILE COVER SHEET

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TI-32390	20-0668	
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Texas Instruments Incorporated

PO Box 655474, M/S 3999 Dallas, TX 75265